



# SMA Plastic-Encapsulate Diodes

## SS310L Schottky Rectifier Diodes

### Features

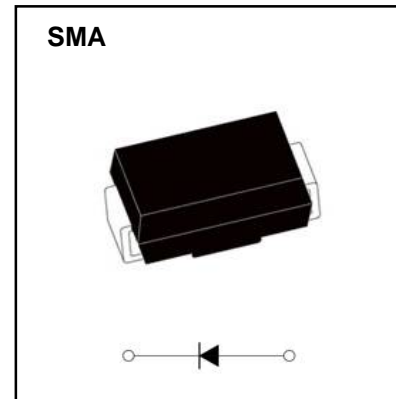
- $I_{F(AV)}$  3A
- $V_{RRM}$  100V
- High surge current capability
- Polarity: Color band denotes cathode

### Applications

- Rectifier

### Marking

- SS310L



### Limiting Values(Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	SS310L
Repetitive Peak Reverse Voltage	$V_{RRM}$	V		100
Maximum RMS Voltage	$V_{RMS}$	V		70
Maximum DC Blocking Voltage	$V_{DC}$	V		100
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, FIG.1	3.0
Surge(Non-repetitive)Forward Current	$I_{FSM}$	A	60Hz Half-sine wave, 1 cycle, $T_a=25^{\circ}C$	120
Junction Temperature	$T_J$	$^{\circ}C$		-55~+150
Storage Temperature	$T_{STG}$	$^{\circ}C$		-55 ~ +150

### Electrical Characteristics (T =25°C Unless otherwise specified)

Item	Symbol	Unit	Test Condition	SS310L	
Peak Forward Voltage	$V_F$	V	$I_F=3.0A$	0.57(TYP) 0.60(MAX)	
Peak Reverse Current	$I_{RRM1}$	mA	$V_{RM}=V_{RRM}$	$T_a=25^{\circ}C$	0.02
	$I_{RRM2}$			$T_a=100^{\circ}C$	20
Thermal Resistance(Typical)	$R_{\theta J-A}$	$^{\circ}C/W$	Between junction and ambient	55	
	$R_{\theta J-L}$		Between junction and terminal	17	

### Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

# Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

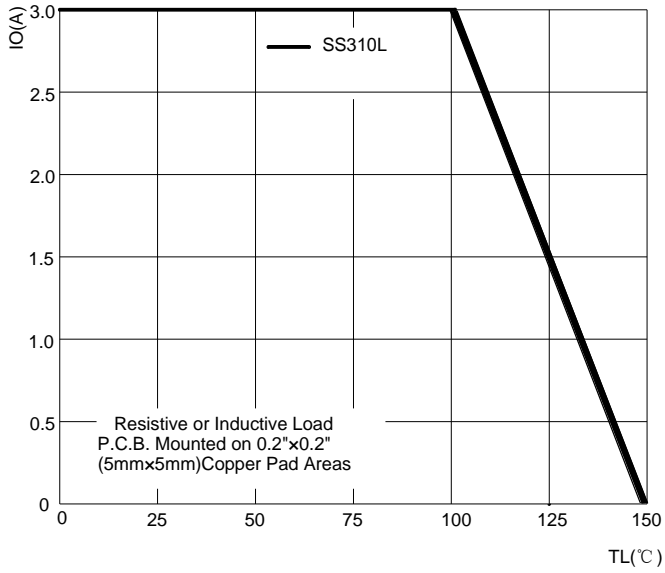


FIG.2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

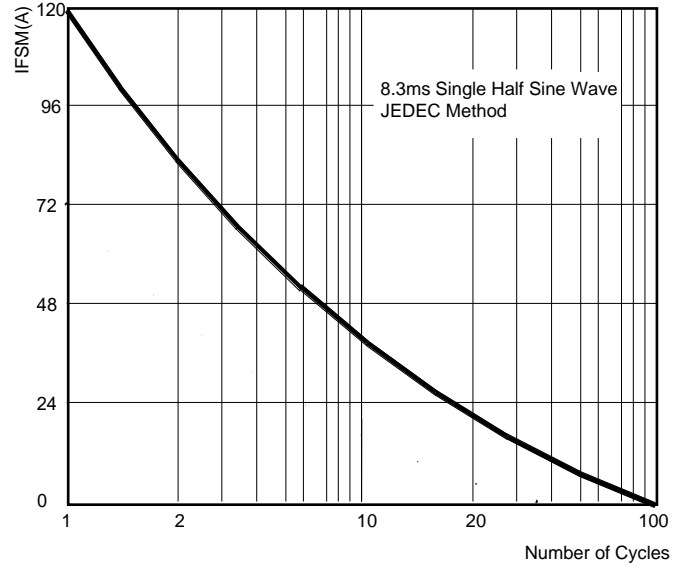


FIG.3: TYPICAL FORWARD CHARACTERISTICS

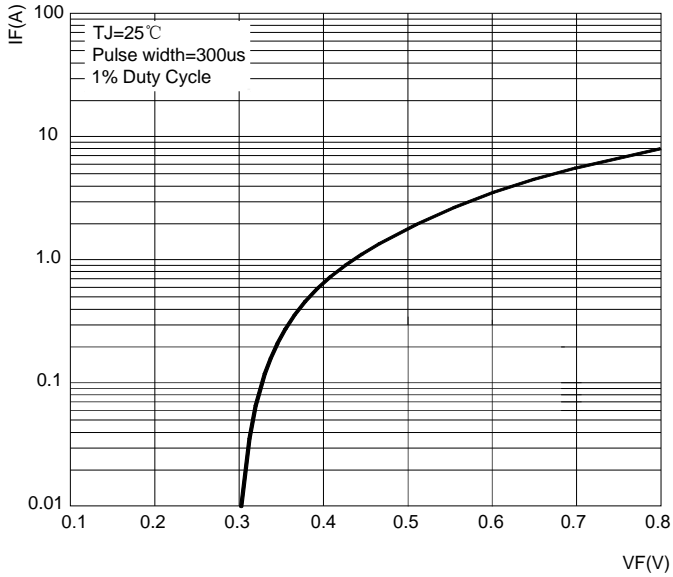
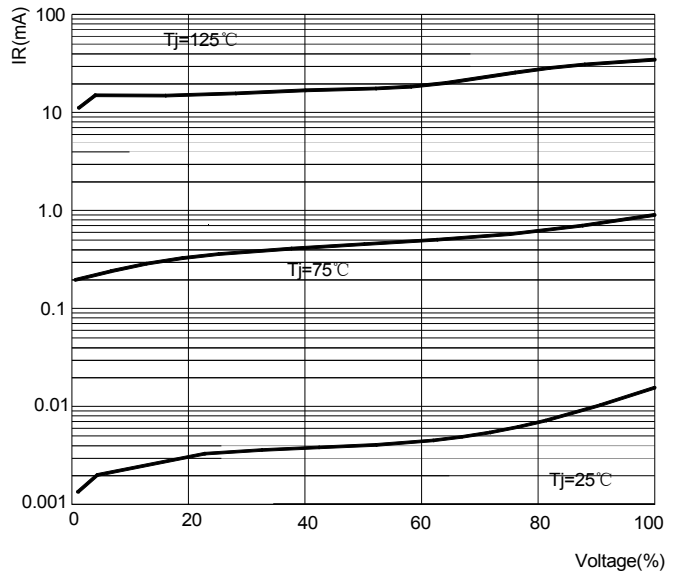
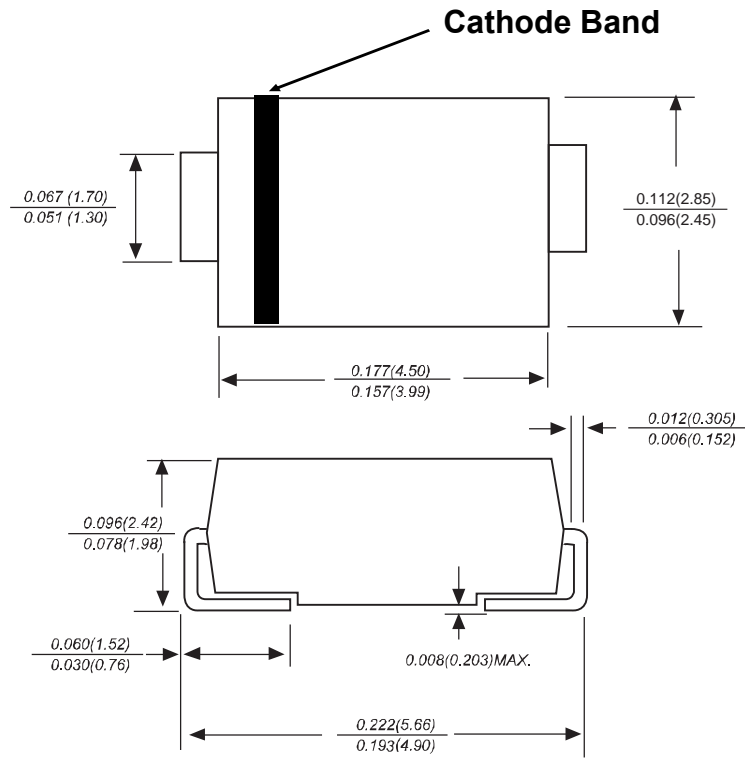


FIG.4: TYPICAL REVERSE CHARACTERISTICS

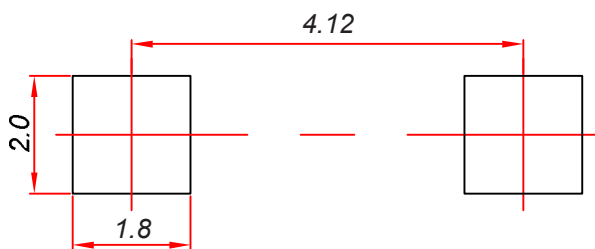


## SMA Package Outline Dimensions



Dimensions in inches and (millimeters)

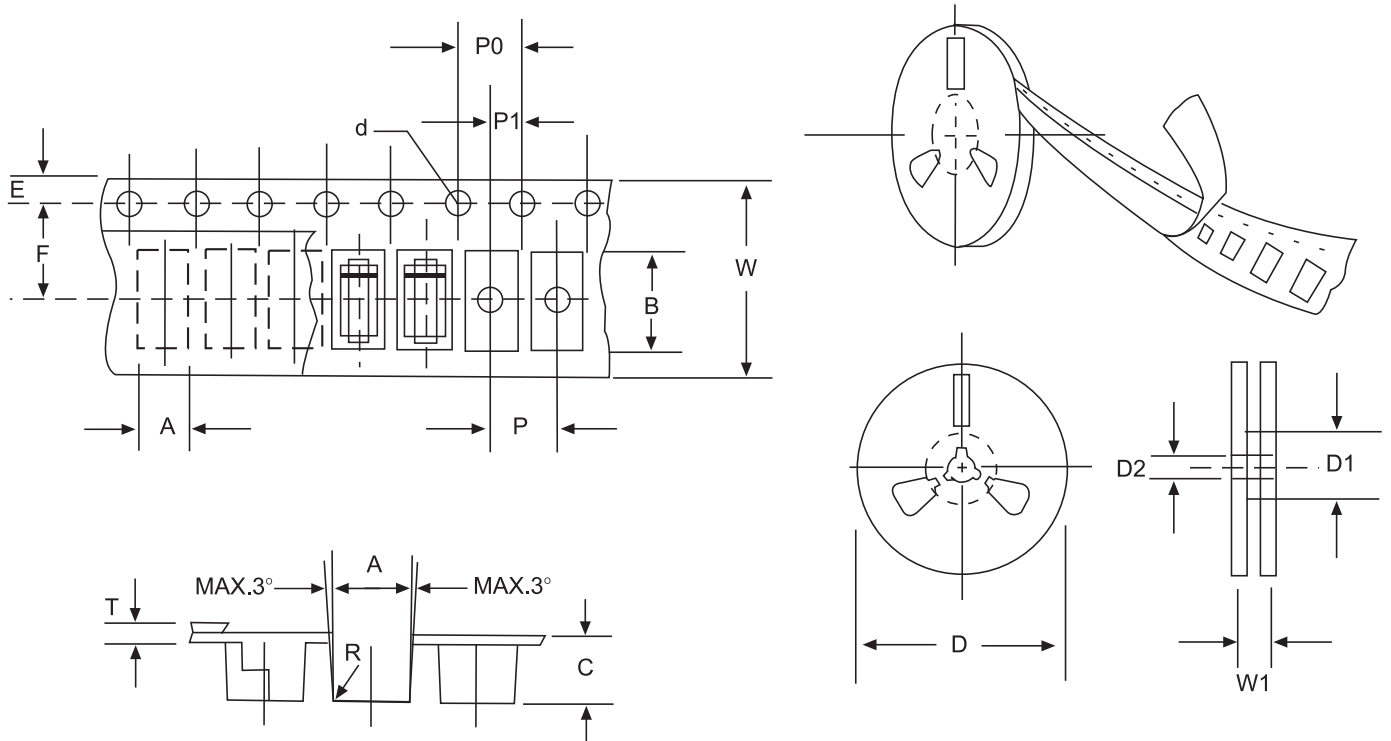
## SMA Suggested Pad Layout



**Note:**

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05mm$ .
3. The pad layout is for reference purposes only.

## Reel Taping Specifications For Surface Mount Devices- SMA



**FIG: CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING**

ITEM	SYMBOL	SMAG mm(inch)
Carrier width	A	2.79±0.1(0.110±0.004)
Carrier length	B	5.33±0.1(0.210±0.004)
Carrier depth	C	2.36±0.1(0.093±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	279±2.0 (11± 0.079)
Reel inner diameter	D1	75 ±1.0 ( 2.95 ±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	5.5±0.05(0.217±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Totall tape thickness	T	0.28±0.02(0.011 ±0.0008)
Tape width	W	12.0±0.2(0.472±0.008)
Reel width	W1	16.8±2.0(0.661±0.079)

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.